
SURFACE MOUNT LED TAPE AND REEL



Lead-Free Parts

LRGY9553/S23/TR1

DATA SHEET

DOC. NO : QW0905-LRGY9553/S23/TR1

REV. : B

DATE : 11 - Sep. - 2014



Features:

1. Top view white LED.
2. white SMT package.
3. Leadframe package with individual 4 pin.
4. Wide viewing angle.
5. Soldering methods: IR reflow soldering.
6. Feature of the device: more light due to higher optical efficiency; extremely wide viewing angle; ideal for backlighting and coupling in light guide.

Descriptions:

The LRGY9553 SMD has wide viewing angle and optimized light coupling by inter reflector, The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

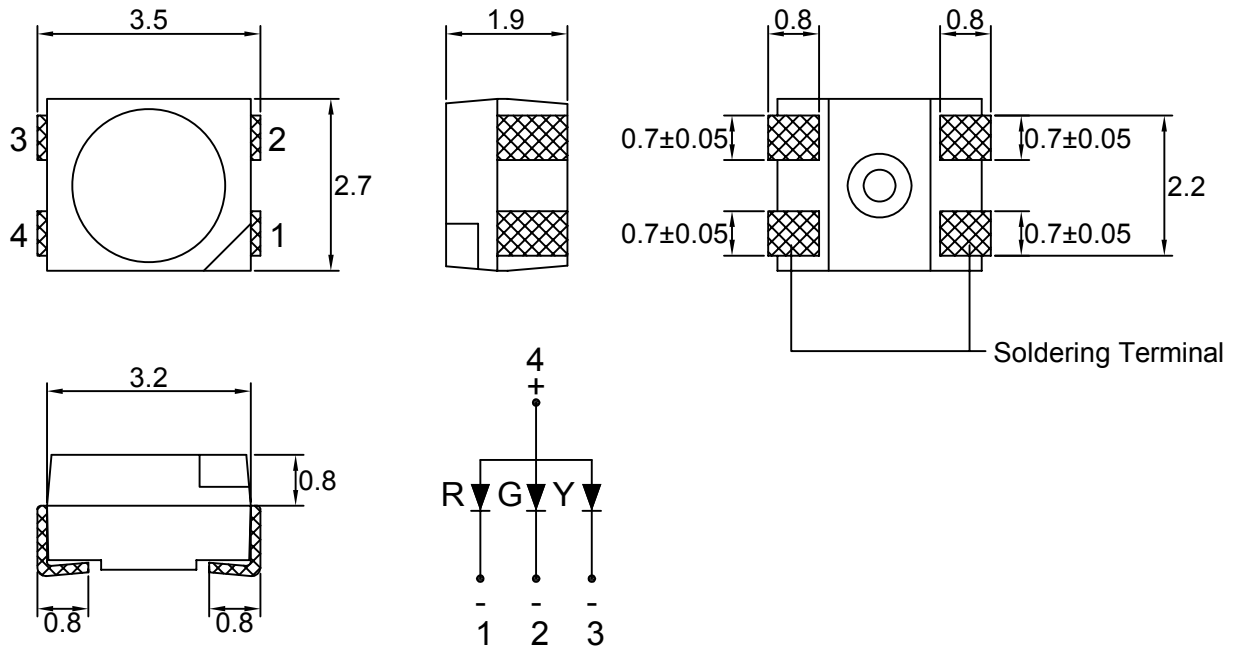
Applications:

1. LCD back light.
2. Mobile phones.
3. Indicators.
4. Switch lights.
5. Lighting.

Device Selection Guide:

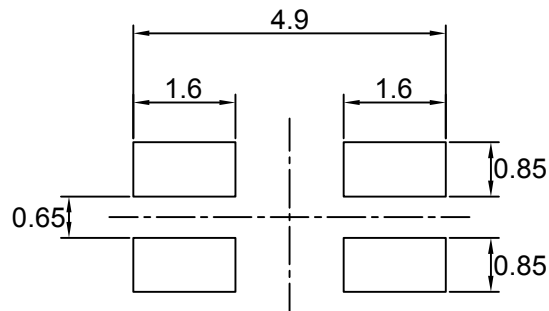
PART NO	MATERIAL	COLOR	
		Emitted	Lens
LRGY9553/S23/TR1	AlGaInP	Red	Water Clear
	InGaN	Green	
	AlGaInP	Yellow	

Package Dimensions



Note : 1.All dimension are in millimeter tolerance is $\pm 0.2\text{mm}$ unless otherwise noted.
2.Specifications are subject to change without notice.

Recommended Soldering Pad Dimensions



Note : The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit=mm.

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Ratings			UNIT
		HEL	DGM	HYS	
Forward Current	IF	30	30	30	mA
Peak Forward Current Duty 1/10@10KHz	IFP	60	100	60	mA
Power Dissipation	PD	78	120	75	mW
Reverse Current @5V	Ir	10	50	10	μA
Electrostatic Discharge	ESD	2000	500	2000	V
Operating Temperature	Topr	- 20 ~ + 80			°C
Storage Temperature	Tstg	- 30 ~ + 100			°C

Typical Electrical & Optical Characteristics (Ta=25°C)

Items	Symbol	Min.	Typ.	Max.	UNIT	CONDITION	
Luminous Intensity	Iv	HEL	200	320	----	mcd	IF=20mA
		DGM	125	250	----		IF=5mA
		HYS	125	250	----		IF=20mA
Dominant Wavelength	λD	HEL	----	624	----	nm	IF=20mA
		DGM	----	525	----		IF=5mA
		HYS	----	587	----		IF=20mA
Spectral Line Half-Width	Δλ	HEL	----	20	----	nm	IF=20mA
		DGM	----	36	----		IF=5mA
		HYS	----	15	----		IF=20mA
Forward Voltage	VF	HEL	1.7	----	2.6	V	IF=20mA
		DGM	2.6	----	3.2		IF=5mA
		HYS	1.7	----	2.6		IF=20mA
Viewing Angle	2θ 1/2	HEL	----	120	----	deg	IF=20mA
		DGM	----	120	----		IF=5mA
		HYS	----	120	----		IF=20mA

Note : 1.The forward voltage data did not including ±0.1V testing tolerance.
 2.The luminous intensity data did not including ±15% testing tolerance.
 3.The color coordinates measurement allowance is ±0.01 testing tolerance.

Luminous Intensity Classification

BIN CODE		lv(mcd) at 20mA	
		Min.	Max.
HEL	S	200	320
	T	320	500
	U	500	800
	V-1	800	1000

BIN CODE		lv(mcd) at 5mA	
		Min.	Max.
DGM	R	125	200
	S	200	320
	T	320	500
	U	500	800

BIN CODE		lv(mcd) at 20mA	
		Min.	Max.
HYS	R	125	200
	S	200	320
	T	320	500
	U	500	800

Typical Electro-Optical Characteristics Curve HEL CHIP

Fig.1 Forward current vs. Forward Voltage

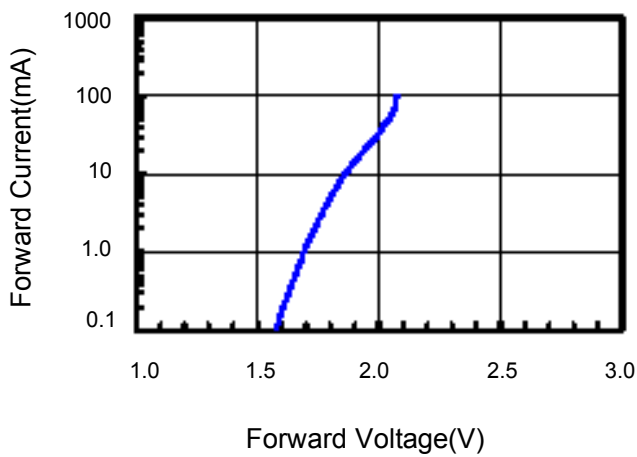


Fig.2 Relative Intensity vs. Forward Current

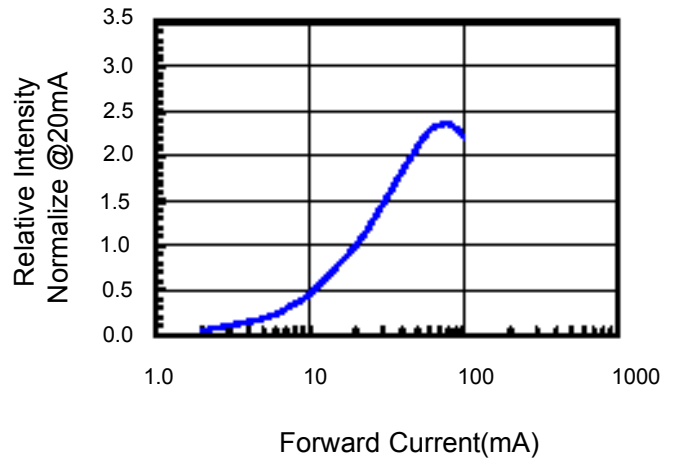


Fig.3 Forward Voltage vs. Temperature

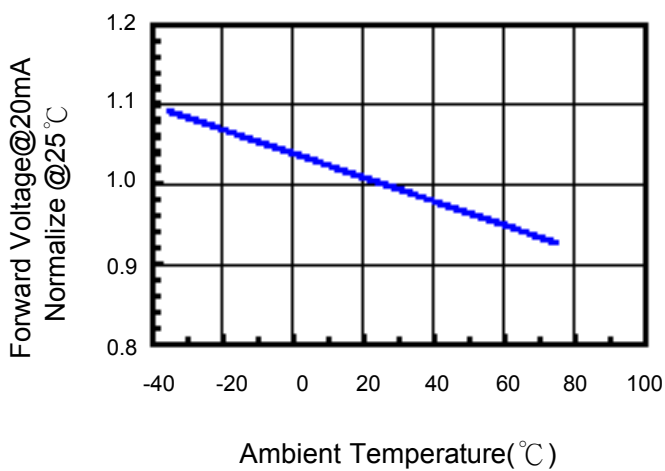


Fig.4 Relative Intensity vs. Temperature

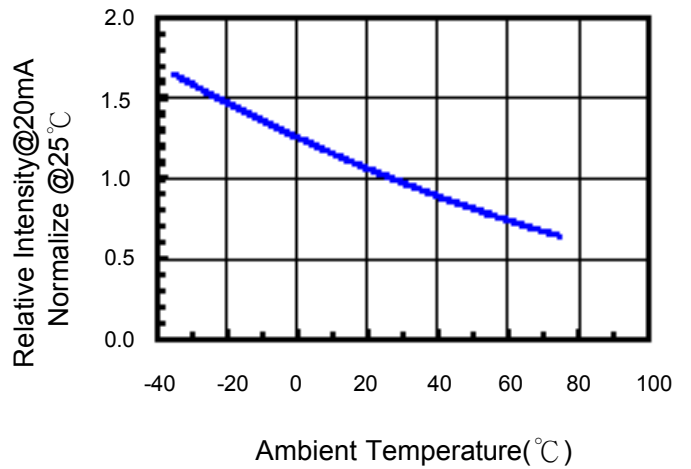


Fig.5 Relative Intensity vs. Wavelength

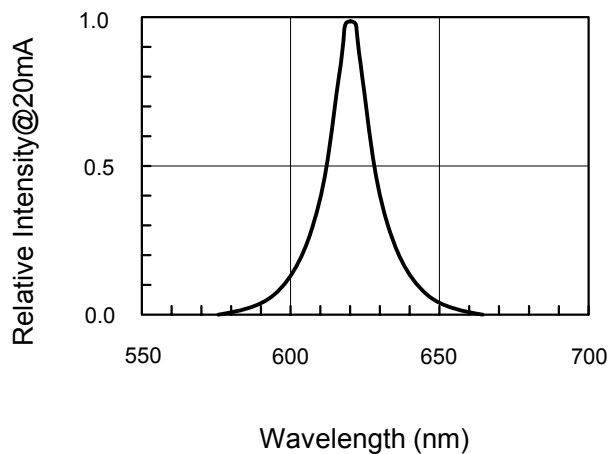
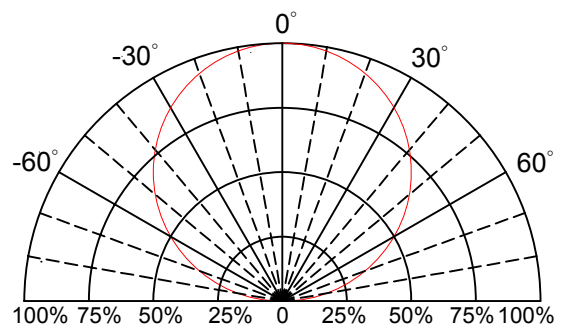


Fig.6 Directive Radiation



Typical Electro-Optical Characteristics Curve

DGM CHIP

Fig.1 Forward current vs. Forward Voltage

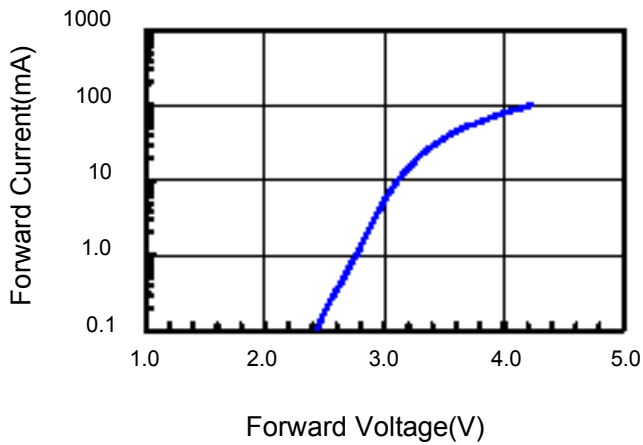


Fig.2 Relative Intensity vs. Forward Current

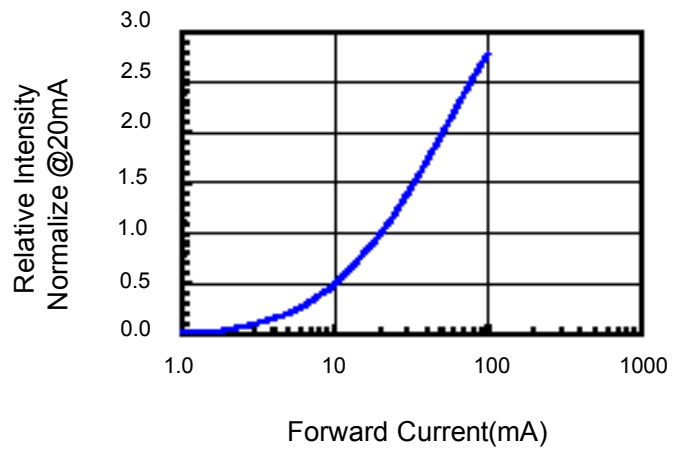


Fig.3 Forward Voltage vs. Temperature

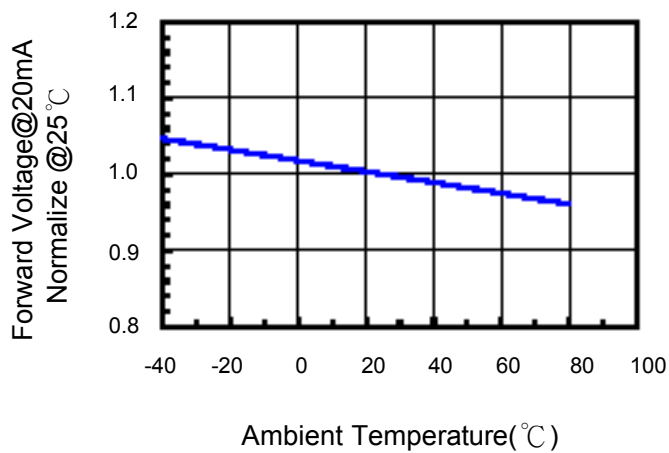


Fig.4 Relative Intensity vs. Temperature

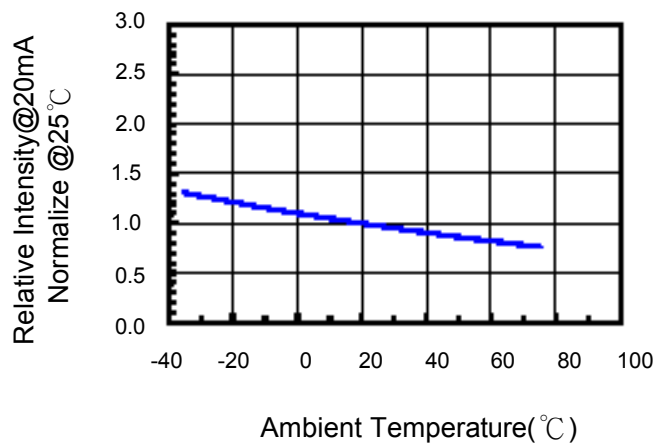


Fig.5 Relative Intensity vs. Wavelength

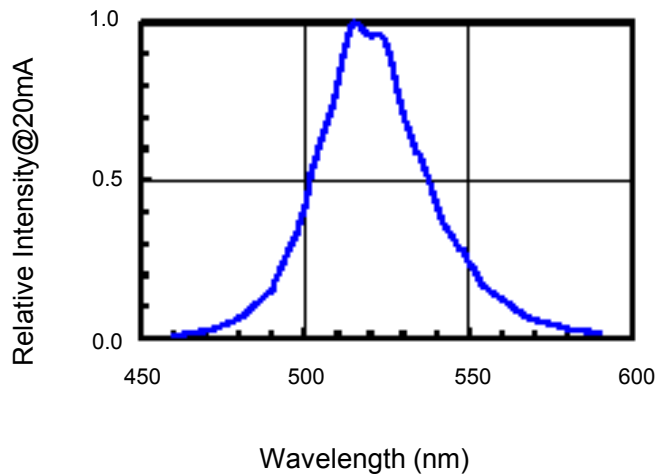
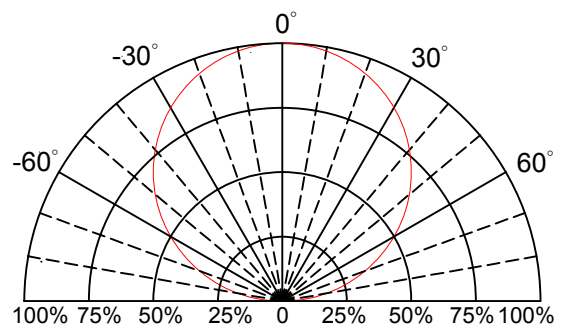


Fig.6 Directive Radiation



Typical Electro-Optical Characteristics Curve HYS CHIP

Fig.1 Forward current vs. Forward Voltage

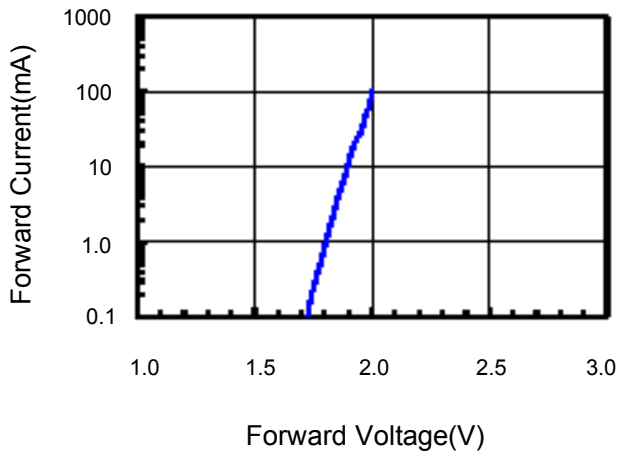


Fig.2 Relative Intensity vs. Forward Current

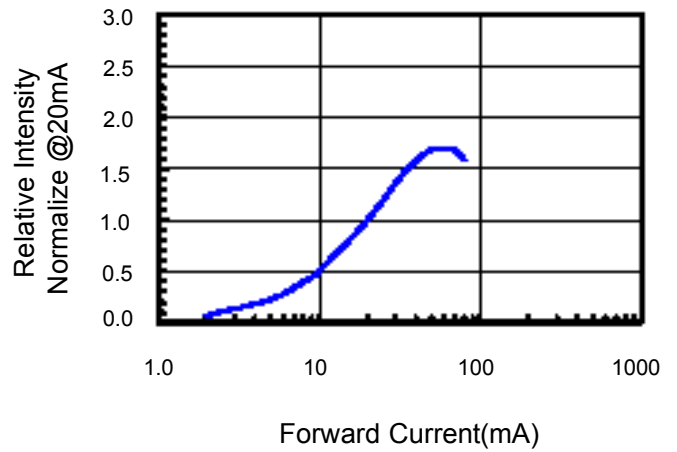


Fig.3 Forward Voltage vs. Temperature

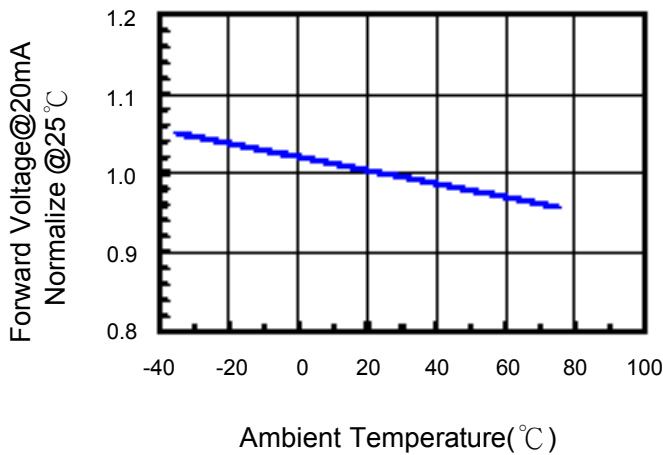


Fig.4 Relative Intensity vs. Temperature

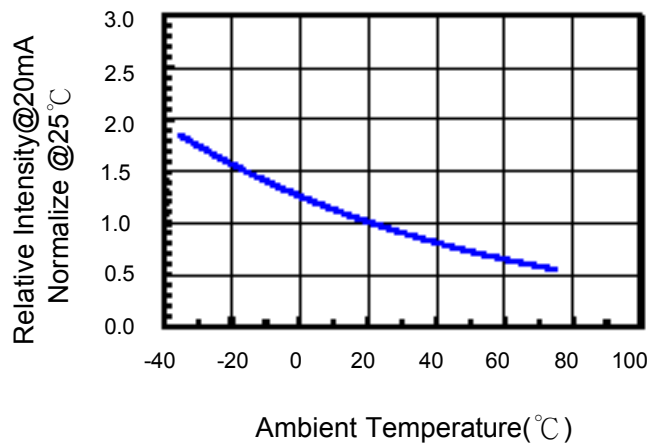


Fig.5 Relative Intensity vs. Wavelength

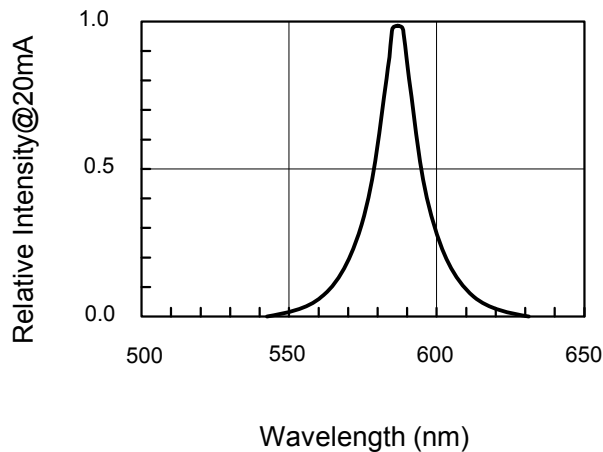
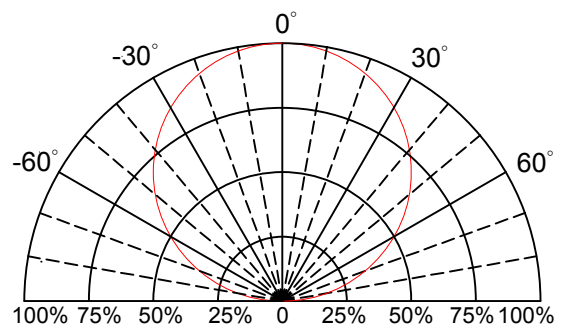
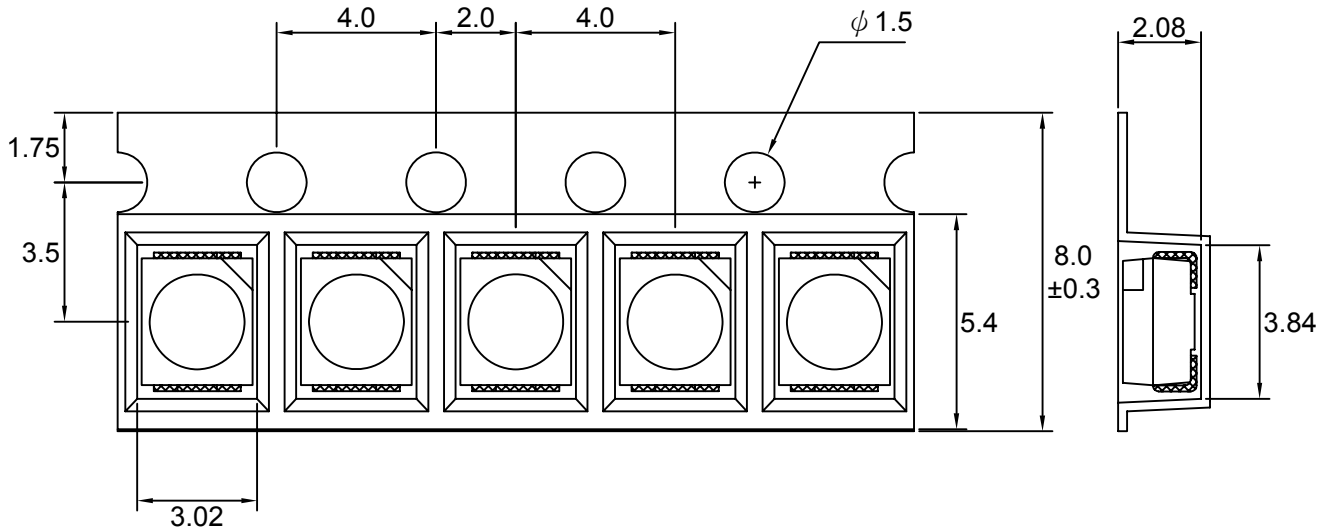


Fig.6 Directive Radiation

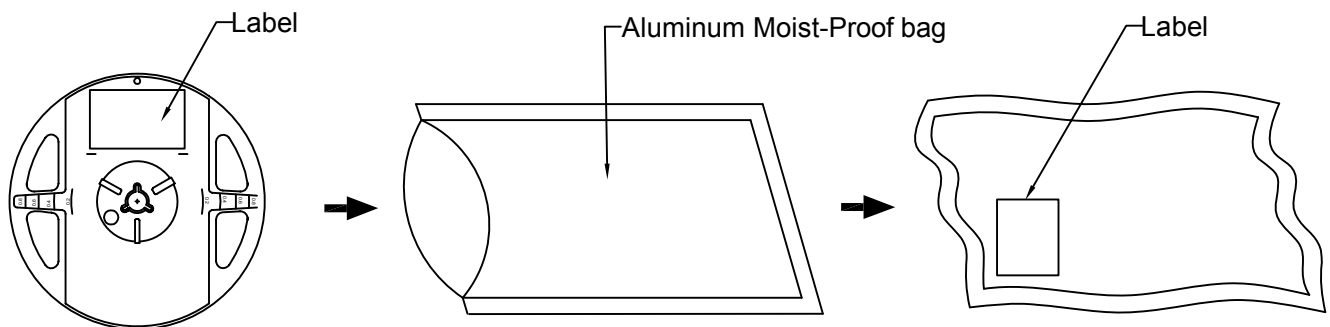


Carrier Type Dimensions




Note : The tolerances unless mentioned is ± 0.1 mm, Angle ± 0.5 . Unit=mm.

• Packing Specifications



Part No.	Description	Quantity/Reel
LRGY9553/S23/TR1	8.0mm tape,7"reel	2000 PCS

Label Explanation

 LIGITEK ELECTRONICS CO., LTD.	
PART :	LRGY9553/S23/TR1/A
LOT :	GS1-070142
QTY(PCS):	2000
BIN/HUE :	S-R-S

VF:1.7-2.6

VF:2.6-3.2

VF:1.7-2.6

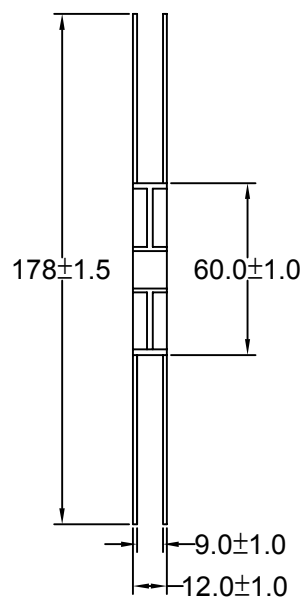
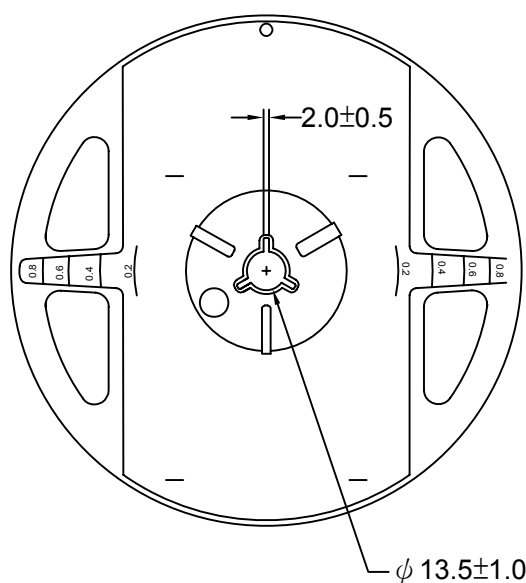
BIN : Luminous Intensity

R CHIP VF : Forward Voltage

G CHIP VF : Forward Voltage

Y CHIP VF : Forward Voltage

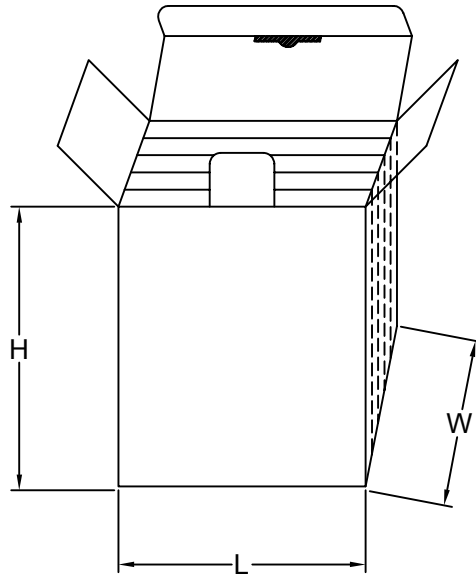
Reel Dimensions



Box Explanation

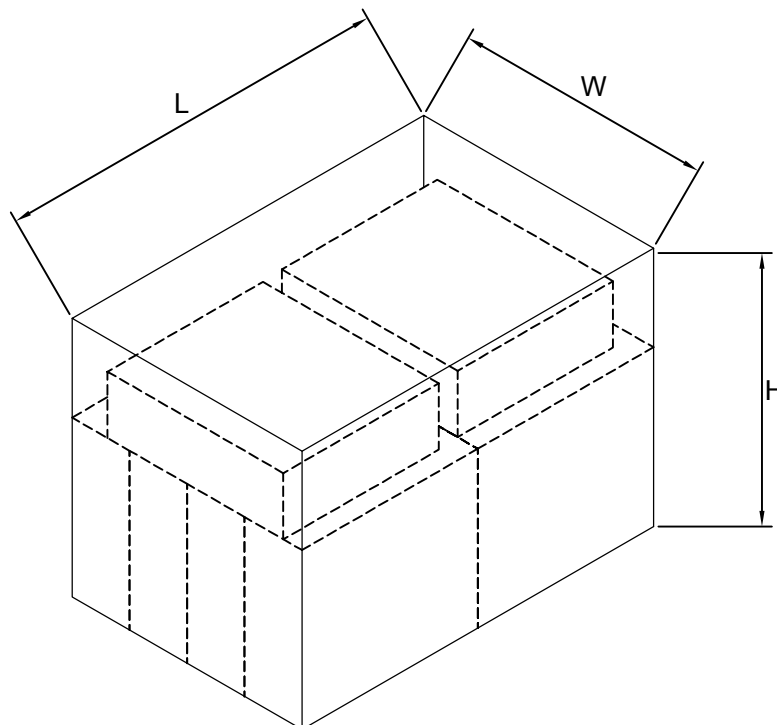
1. 5 BAG / INNER BOX

2. INNER BOX SIZE : L X W X H 23cm X 8.5cm x 26cm



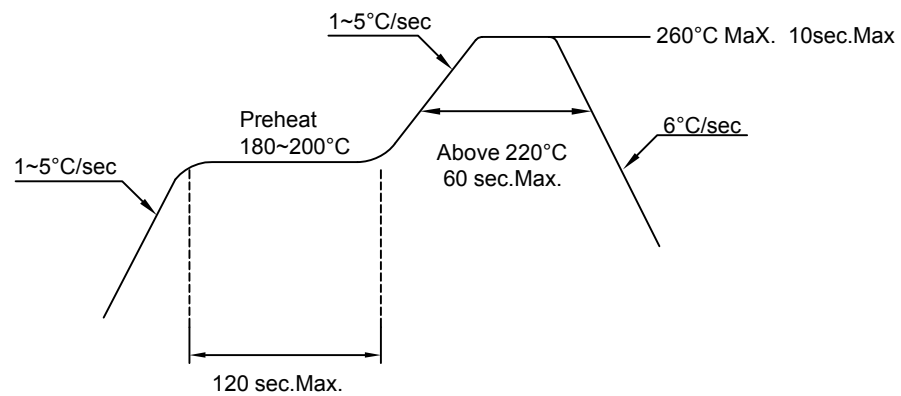
3. 10 INNER BOXES / CARTON

4. CARTON SIZE : L X W X H 58cm X 34cm x 35cm



Recommended Soldering Conditions**1. Hand Solder**

Basic spec is $\leq 320^{\circ}\text{C}$ 3 sec one time only.

2. PB-Free Reflow Solder**Note:**

- 1.Reflow soldering should not be done more than two times.
- 2.When soldering,do not put stress on the LEDs during heating.
- 3.After soldering,do not warp the circuit board.

Precautions For Use:**Storage time:**

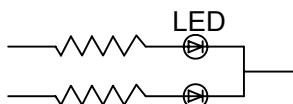
- 1.The operation of Temperatures and RH are : $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$,RH60%.
- 2.Once the package is opened, the products should be used within a week.
Otherwise, they should be kept in a damp proof box with descanting agent.
Considering the tape life, we suggest our customers to use our products within a year(from production date).
- 3.If opened more than one week in an atmosphere $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$,RH60%, they should be treated at $60^{\circ}\text{C} \pm 5^{\circ}\text{C}$ fo r 15hrs.

Drive Method:

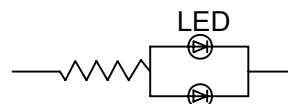
LED is a current operated device, and therefore, requirer some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in series with the LED.

Consider worst case voltage variations than could occur across the current limiting resistor. The forwr d current should not be allowed to change by more than 40% of its desired value.

Circuit model A



Circuit model B



(A) Recommended circuit.

(B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

ESD(Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing these LED. All devices, equipment and machinery must be properly grounded.

Reliability Test:

(1)Test items and results

Classification	Test Item	Test Condition	Sample Size
Endurance Test	Operating Life Test	1.Ta=Under Room Temperature As Per Data Sheet Maximum Rating. 2.If=20mA 3.t=1000 hrs	22
	High Temperature Storage Test	1.Ta=105°C±5°C 2.t=500 hrs	22
	Low Temperature Storage Test	1.Ta=-40°C±5°C 2.t=1000 hrs	22
	High Temperature High Humidity Storage Test	1.IR-Reflow In-Board, 2 Times 2.Ta=85°C±5°C 3.RH=90%~95% 4.t=500hrs±2hrs	22
Environmental Test	Thermal Shock Test	1.IR-Reflow In-Board,2 times 2.Ta=105°C ±5°C & -40°C±5°C (30min) (30min) 3.total 100 cycles	22
	Reflow Soldering Test	1.T.Sol=260°C±5°C 2.Dwell Time= 10Max.	22
	Temperature Cycling	1.105°C ~ 25°C ~ -40°C 30mins 15mins 30mins 2.100 Cyeles	22

(2)Criteria for judging the damage

Item	Symbol	Test Conditions	Criteria for Judgement	
			Min.	Max.
Forward Voltage	Vf	If=20mA	-	U.S.L x1.2
Reverse Current	Ir	Vr=5V	-	U.S.L x2.0
Luminous Intensity	Iv	If=20mA	L.S.L x 0.5	-

Note:

- 1.U.S.L.:Upper Standard Level.
- 2.L.S.L.:Lower Standard Level.